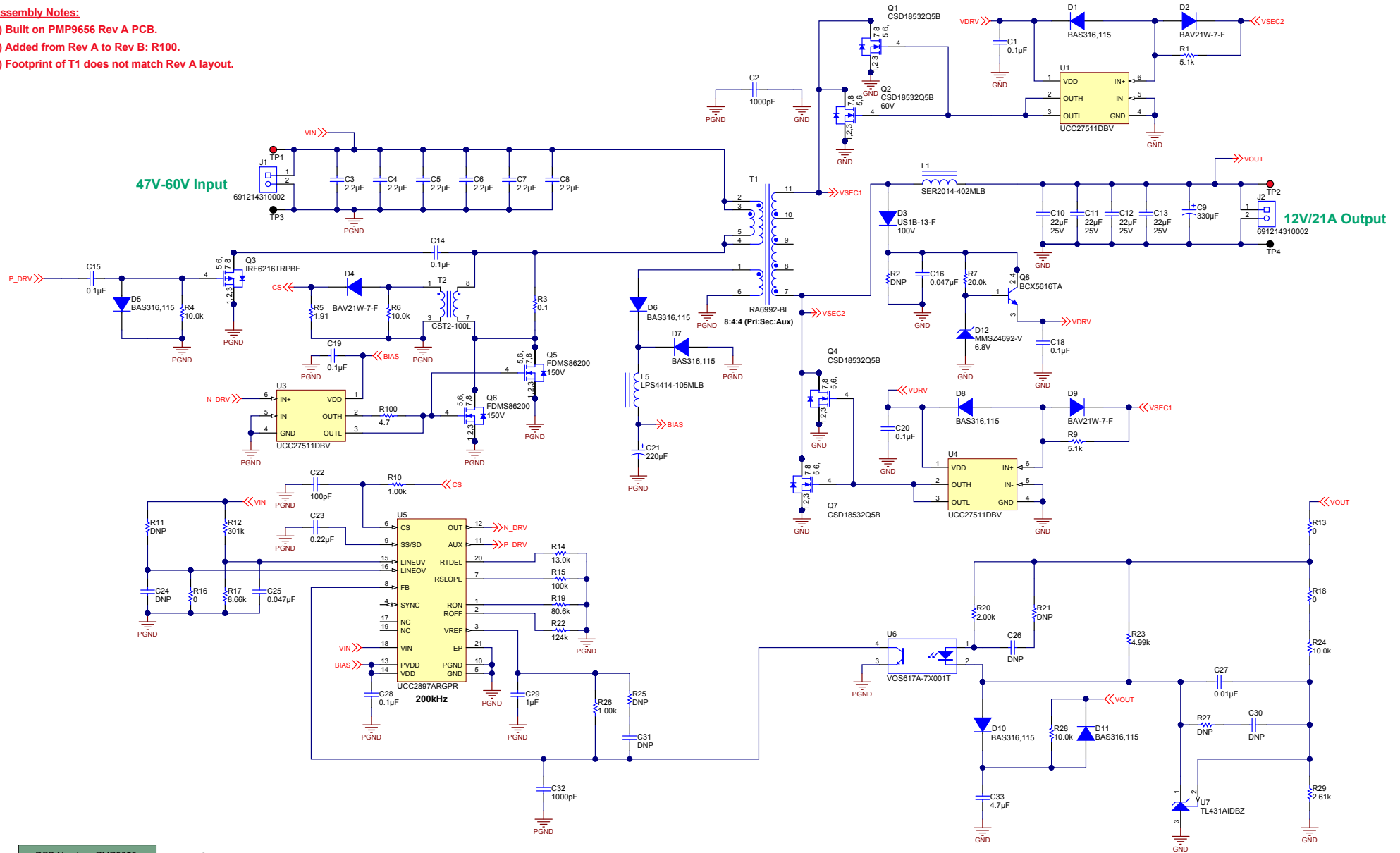


Assembly Notes:

- 1) Built on PMP9656 Rev A PCB.
- 2) Added from Rev A to Rev B: R100.
- 3) Footprint of T1 does not match Rev A layout.



PCB Number: PMP9656
PCB Rev: A

PCB
LOGO
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| | | | | | | | |
|---------------------------------|--|-----------------------|--|--|--|---|--|
| Number: PMP9656 | | Rev: B | | Designed for: Project Title: 47-60Vin, 12V/21A Active Clamp Forward | | Mod. Date: 5/14/2014 | |
| SVN Rev: Not in version control | | Assembly Variant: 001 | | Sheet Title: | | Sheet: 1 of 1 | |
| Drawn By: | | Engineer: B King | | File: PMP9656_REV B_SchDoc | | Size: B | |
| | | | | Contact: http://www.ti.com/support | | http://www.ti.com | |

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